

Ethernet Alliance TEF 2021: The Road Ahead

New Applications Driving Higher Bandwidths



TECHNOLOGY
EXPLORATION
FORUM



ethernet alliance

www.ethernetalliance.org

The Ethernet Alliance

Global Community of End Users, System Vendors, Component Suppliers & Academia

Our Mission

- **To promote** industry awareness, acceptance and advancement of technology and products based on, or dependent upon, both **existing and emerging IEEE 802 Ethernet standards** and their management.
- **To accelerate industry adoption** and remove barriers to market entry by providing a cohesive, market-responsive, industry voice.
- Provide resources to establish and **demonstrate multi-vendor interoperability.**



Ethernet Alliance Strategy

Expanding the Ethernet Ecosystem, Supporting Ethernet Development

- Facilitate interoperability testing
 - Industry Plug Fests supporting member and technology initiatives
- Interoperability Assurance
 - PoE Certification Program
- Collaborative Interaction with other Industry Organizations
 - Multiple SIGs, Applications and MSAs
 - Industry Consensus Building
- Global Outreach
 - Worldwide Membership
- Thought Leadership
 - EA Hosts Technology Exploration Forums (TEFs)
 - Technology and Standards incubation
- Promotion of Ethernet
 - Industry Analysts
 - Education
 - Marketing
 - *Trade shows & Panel Presentations*
 - *White Papers, Blogs & Social Media*

NEW APPLICATIONS DRIVING HIGHER BANDWIDTHS

Moderator – Nathan Tracy, *Ethernet Alliance Board Member & TE Connectivity*

Panelists –Brad Booth, *Microsoft*,- “*Paradigm Shift in Network Topologies*”

Rob Stone, *Facebook* – “*Co-Package Optics for Datacenters*”

Tad Hofmeister, *Google* – “*OIF Considerations for Beyond 400ZR*”



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New Applications Driving Higher Bandwidth



**Moderator: Nathan Tracy, *Ethernet Alliance*
Board Member & TE Connectivity**



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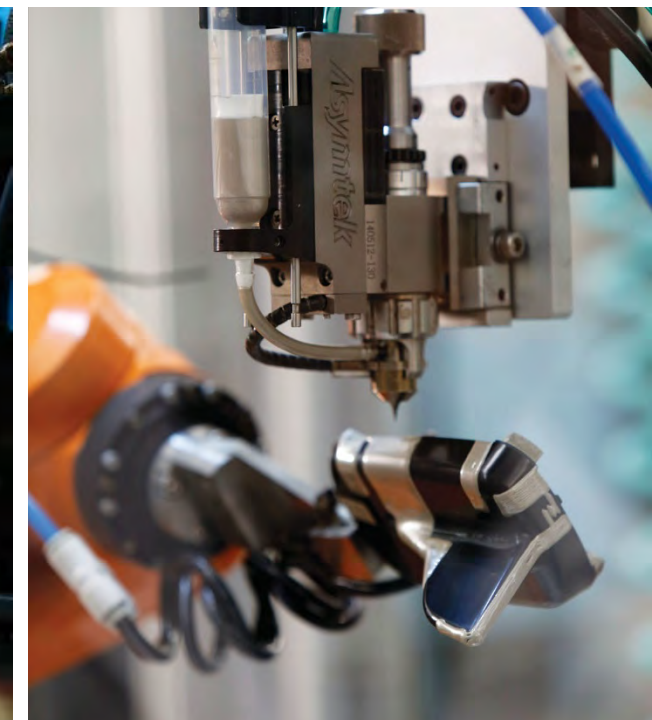
New Applications Driving Higher Bandwidth

or

There's a Bandwidth Problem? Where did that Come From?

Nathan Tracy
Technologist
TE Connectivity
January 26, 2021

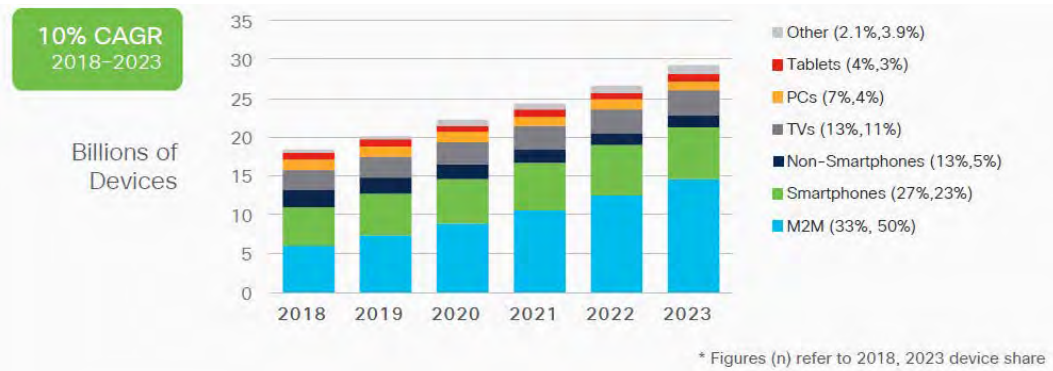
EVERY CONNECTION COUNTS



2018-2023 Internet User Trends



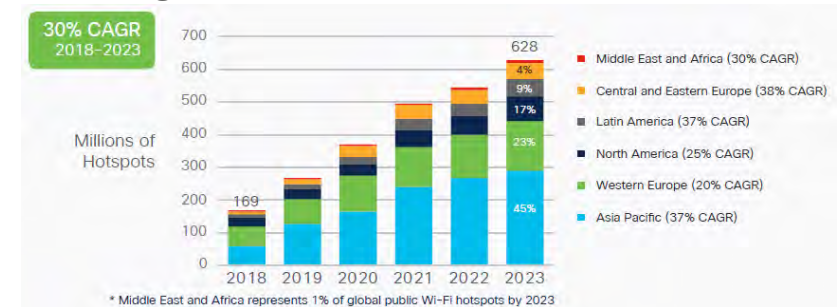
Devices and Connections: growing faster (10% CAGR) than population (1% CAGR) and users (6% CAGR)



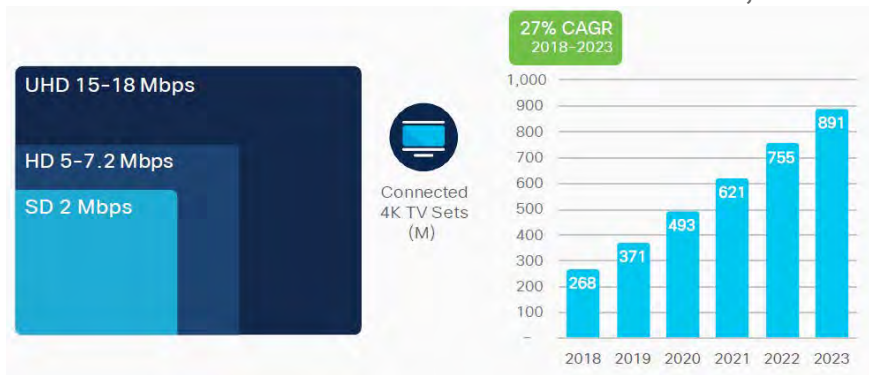
M2M Connections: 19% CAGR, 1.8 connections per capita, by 2023 will be 50% of all connections



WiFi: Speeds from mobile devices will be 3x faster from '18 to '23
Number of hot spots will grow 4x from '18 to '23



Video: Use of 4K TV's will grow from 33% in '18 to 66% in '23
4K bit rate is double HDTV and 9 times SDTV,

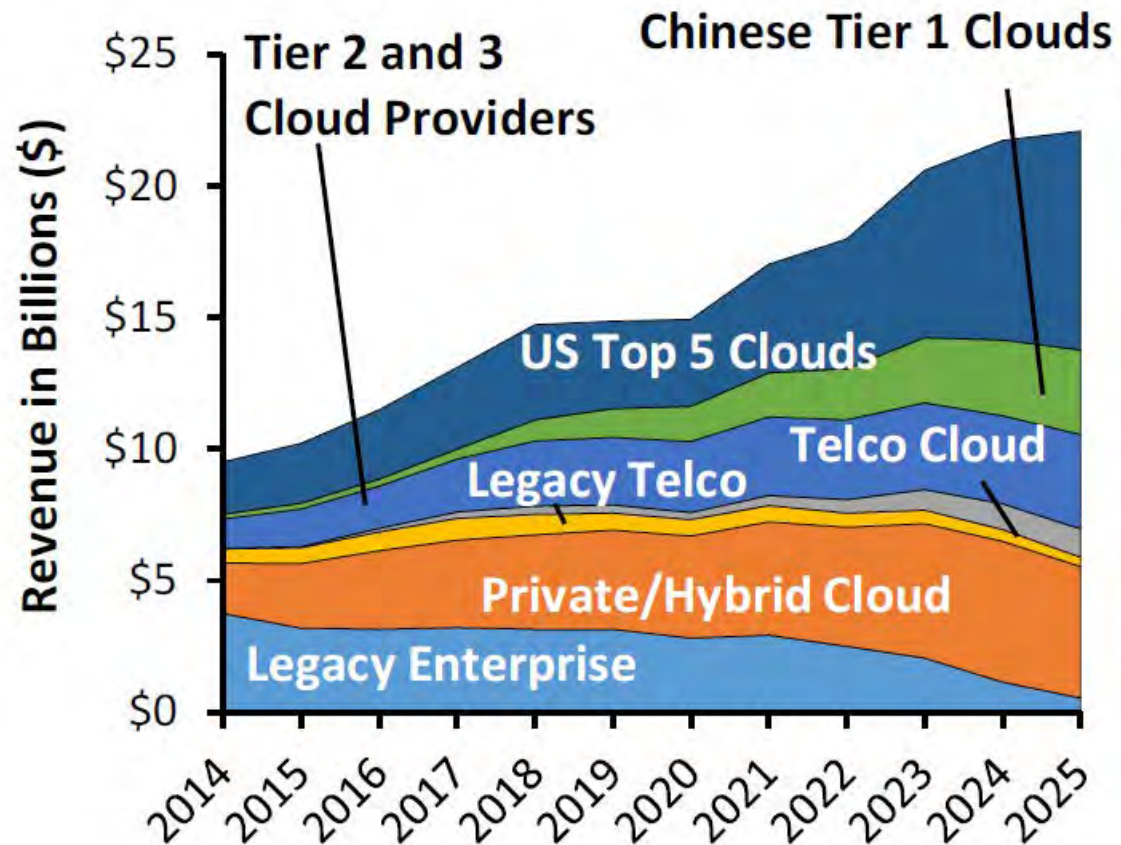


Mobility: >70% of the global population by '23,
5G will be >10% by '23 @13X faster than the avg mobile connection

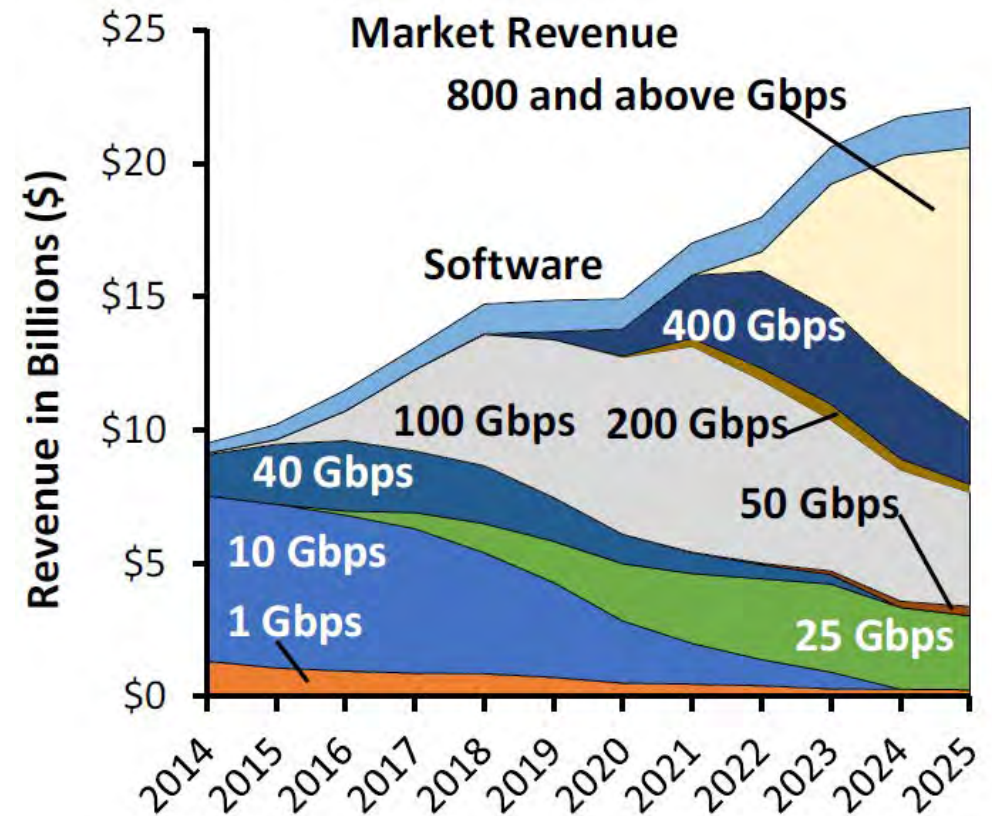


Ethernet Switch Growth Forecast

Data Center Ethernet Switch Market Revenue By Application

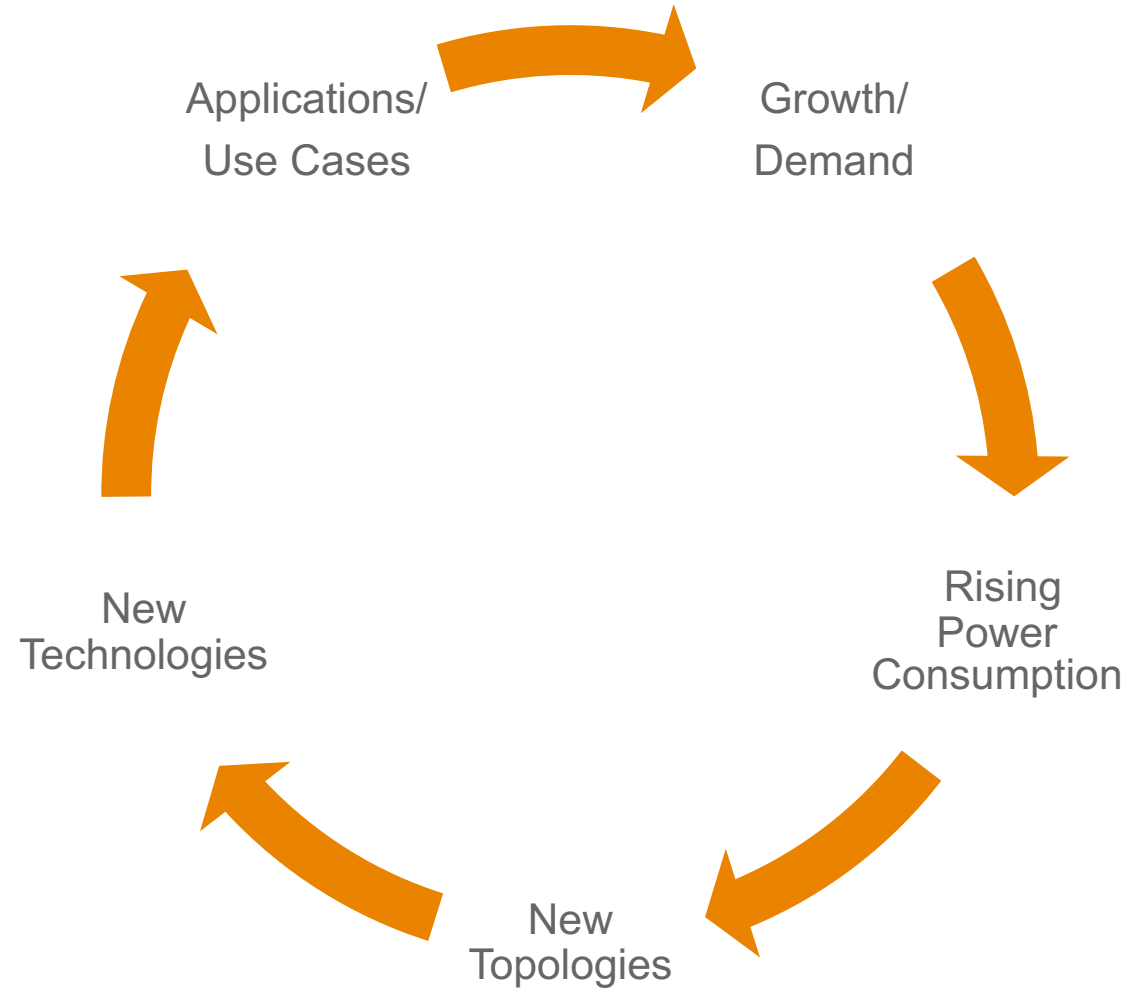


Data Center Ethernet Switch Market Revenue By Speed



Dynamics Affecting Network Bandwidth

Where are we at on the “fly wheel”?



Paradigm Shift in Network Topologies



Brad Booth, *Microsoft*



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Paradigm Shift in Networking Topologies

Brad Booth
Ethernet Alliance TEF January 2021

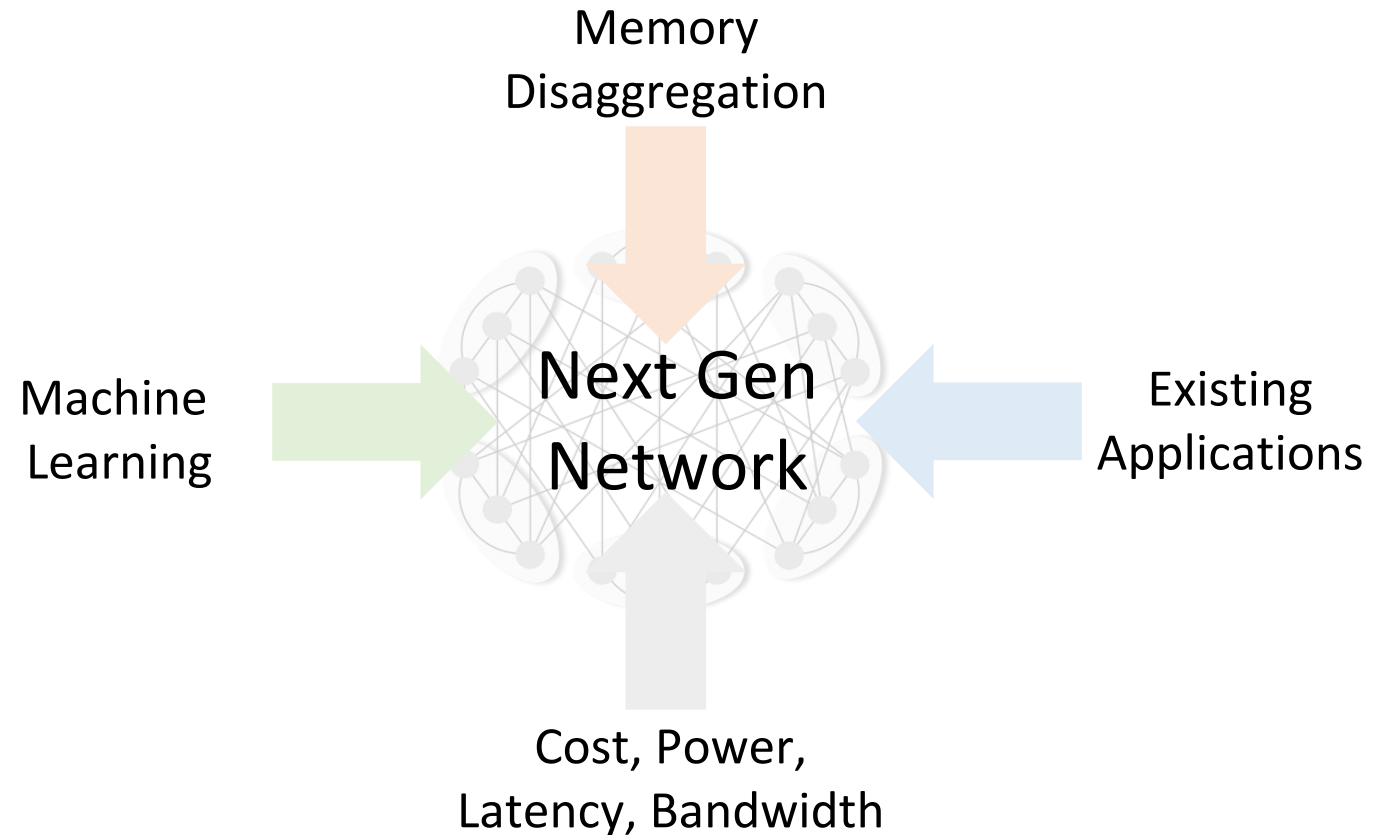
Key Drivers for Next Generation Networking

Observations

- Growing data intensive usage models
- System repartitioning trends (CapEx)
- Increasing sensitivity energy consumption (network tax)

Implications

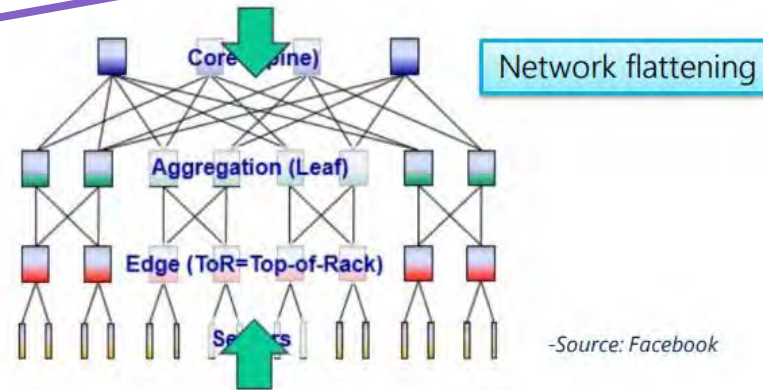
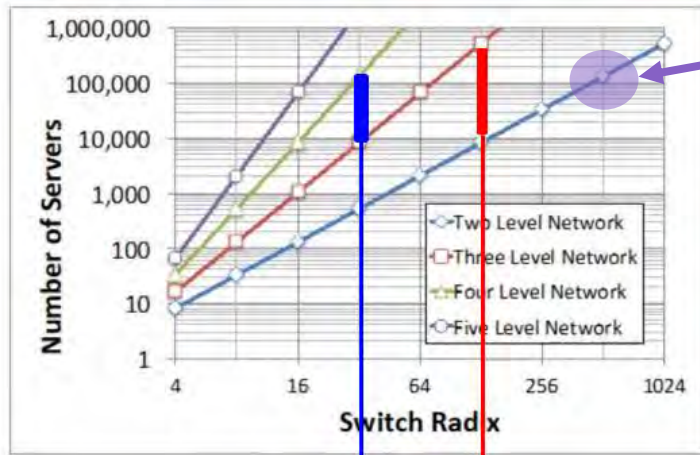
- Energy efficiency (low pJ / bit)
- Maximum use of available bandwidth
- Low latency
- Silicon bandwidth density (Gbps/mm²)
- System and component cost
- Error handling/correction
- Link reliability/redundancy



Networking Topologies Shifting to Meet Next Generation Demands

Focus on Flows

Radix = 512, 100K servers, 32MW DC, Two Tiers



-Source: Facebook

- Fewer tiers = decreased latency, lower power
- CPU bandwidth ~ 1G/core
- Volume of servers vs. power grid

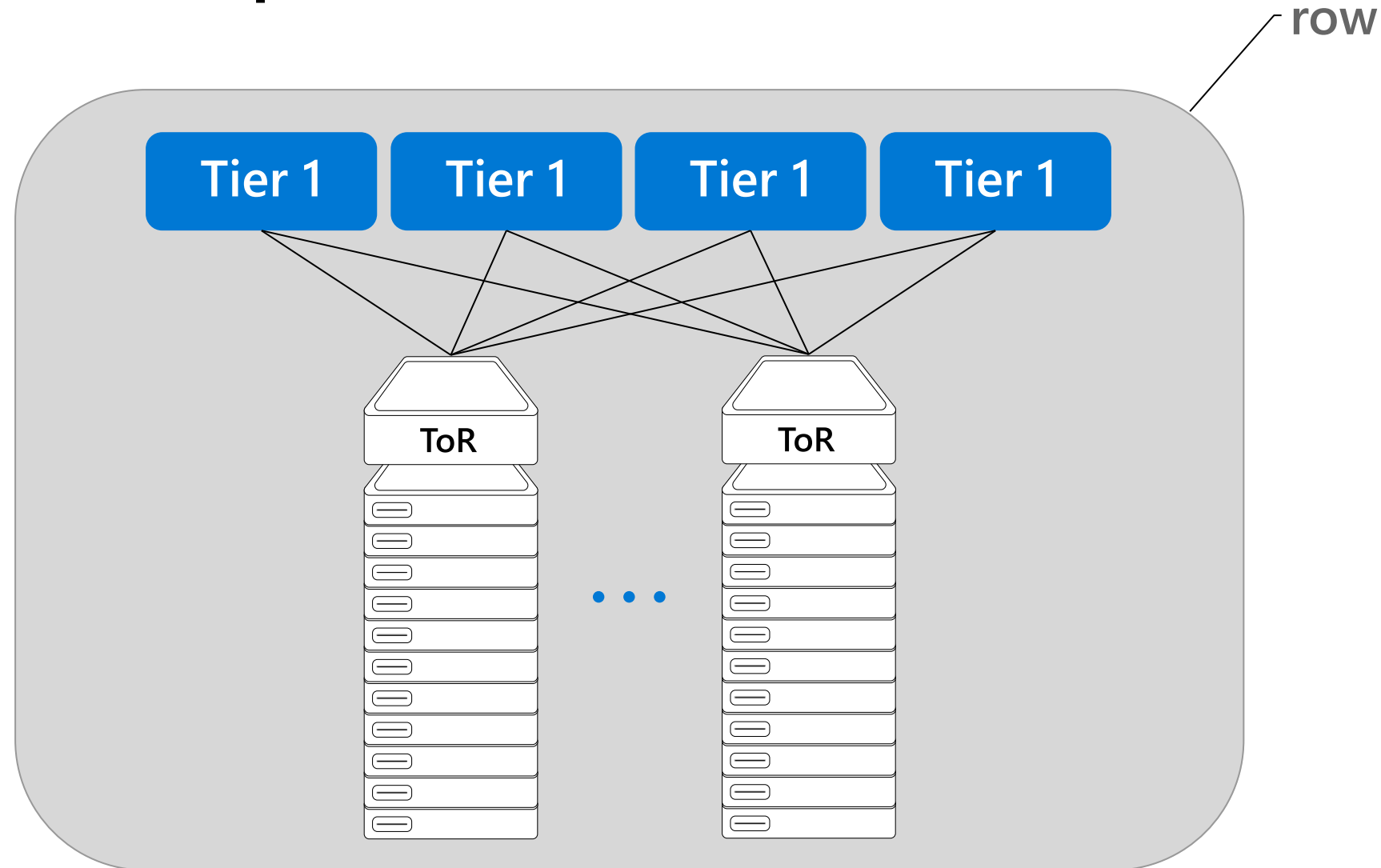
Switch Generation	Radix = 32	Radix = 64	Radix = 128
12.8T	400G	200G	100G
25.6T	800G	400G	200G
51.2T	1.6T	800G	400G

Optical interconnects

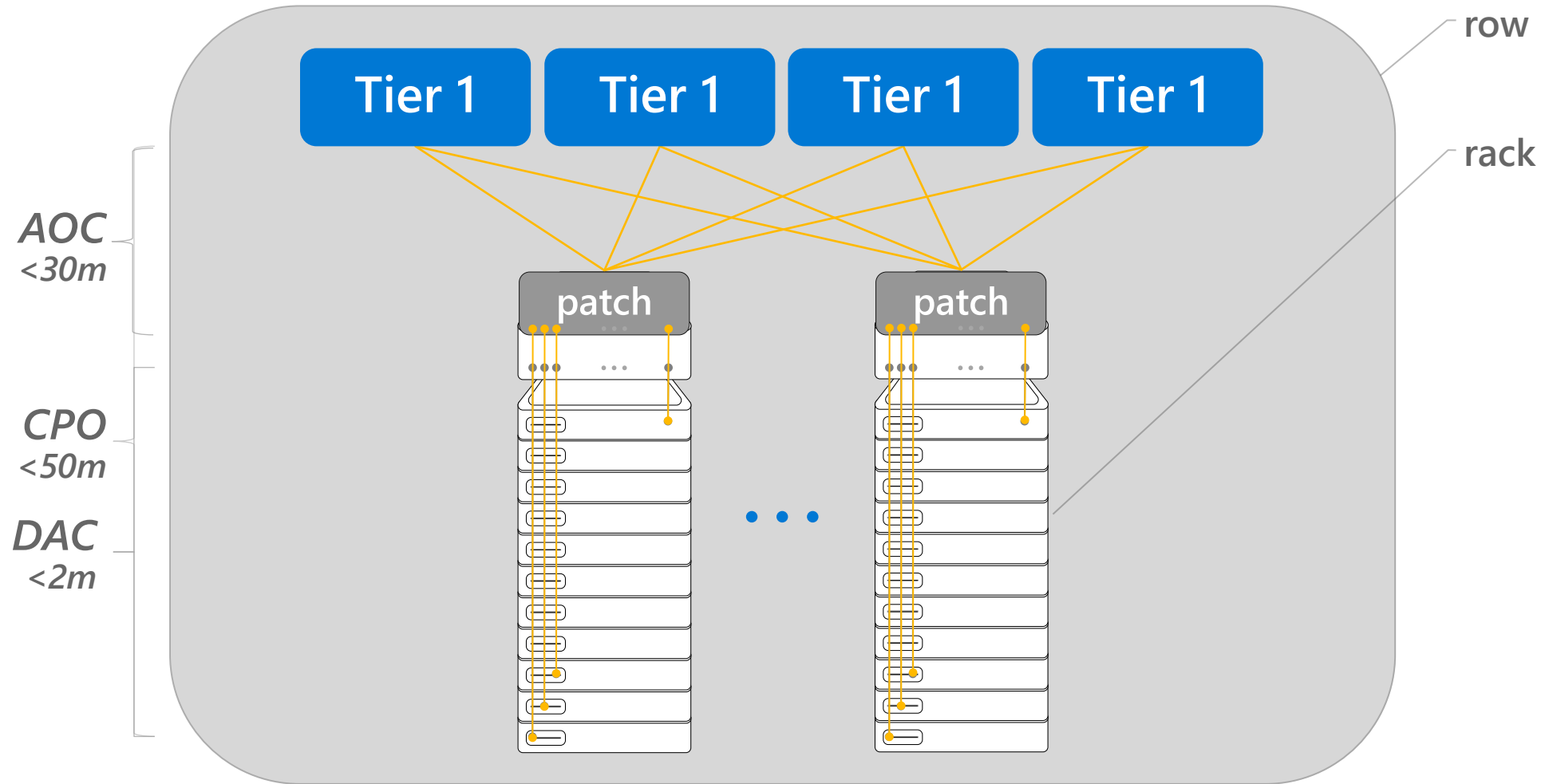
Topology Change Example

Is a ToR valuable?

- Stranded ports in high radix switches
- Additional latency & power
- Single point of failure
- Enables the use of DAC... for now



ToR Elimination





Summary

- ✓ Power is a growing challenge with increased data rates
- ✓ High radix switches plus optical interconnects enable new networking topologies
- ✓ Topology changes eliminate port stranding, reduce latency and improve energy efficiency
- ✓ New networking paradigm: Focus on the Flows



Co-Package Optics for Datacenters



Rob Stone, Facebook



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Co-packaged Optics in the Datacenter

Ethernet Alliance Technology Exploration Forum
January 2021

Rob Stone
robstone@fb.com

FACEBOOK Infrastructure

Agenda

Problem Statement

New Workloads and Endpoints

CPO for Network Switching

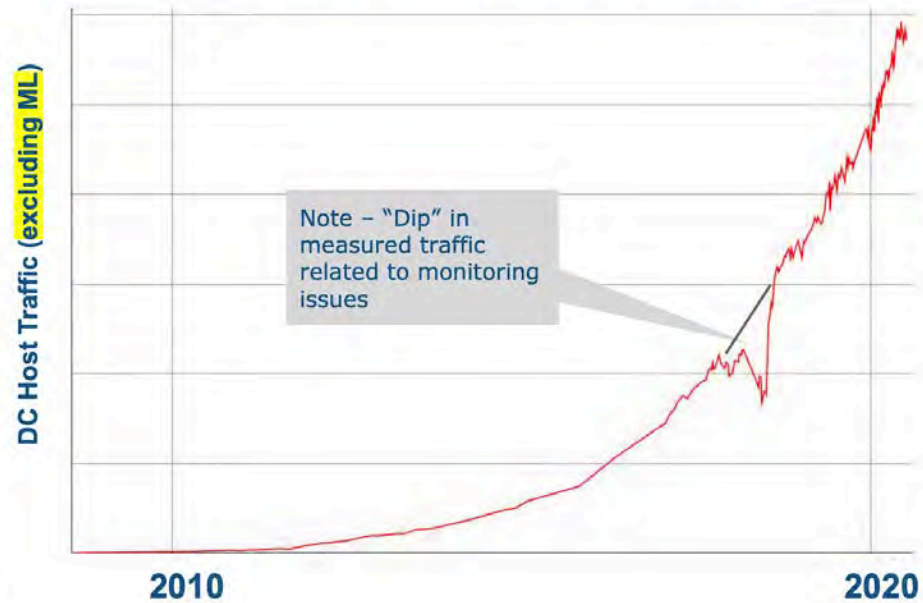
Network Timeline / Roadmap

Industry Initiatives

Conclusions

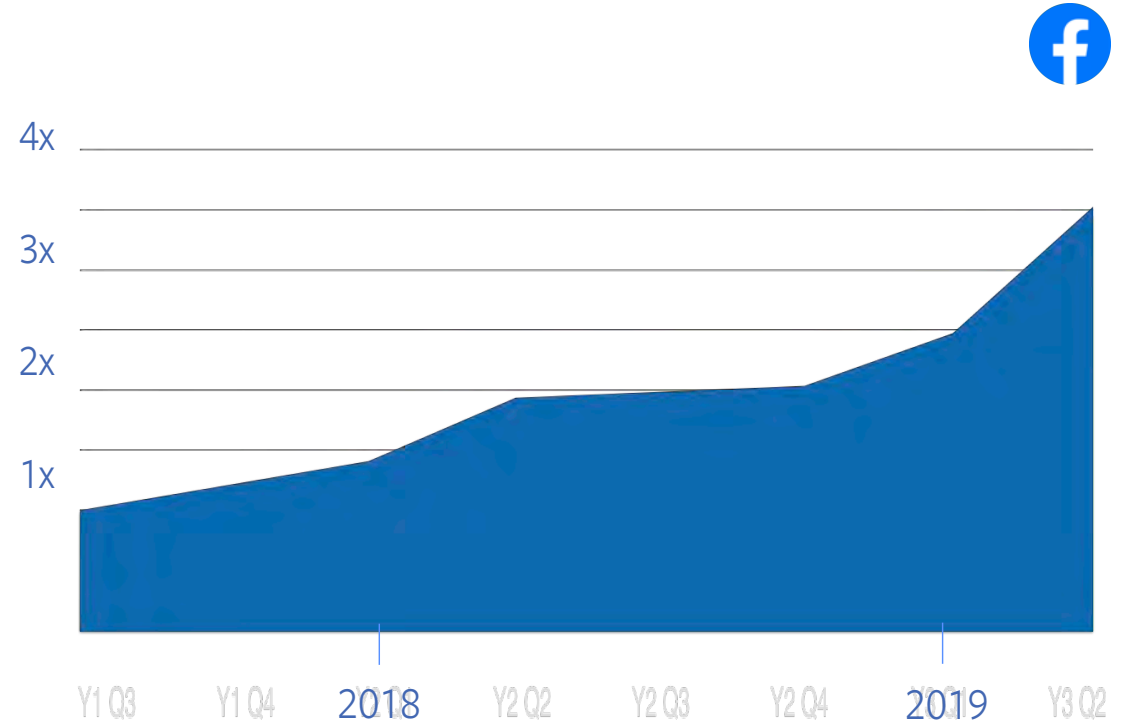
Continued Datacenter Bandwidth Growth

Data Center Traffic (ex ML)



IEEE Beyond 400 Gb/s Ethernet CFI consensus presentation
(Cedric Lam, Google)

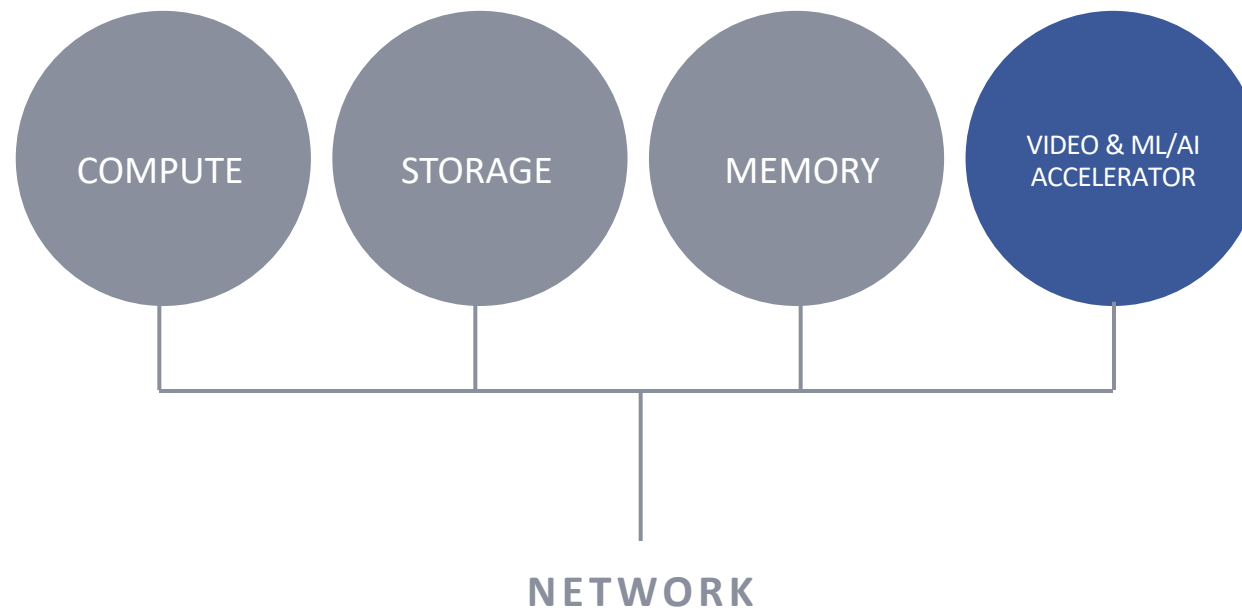
AI Inference



Vijay Rao OCP Keynote 2019



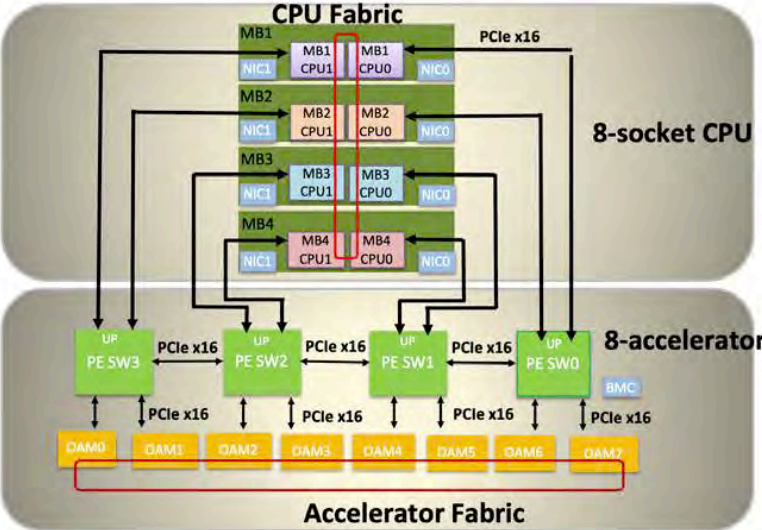
Changing Workloads



New Accelerators Driving Higher Network Demand

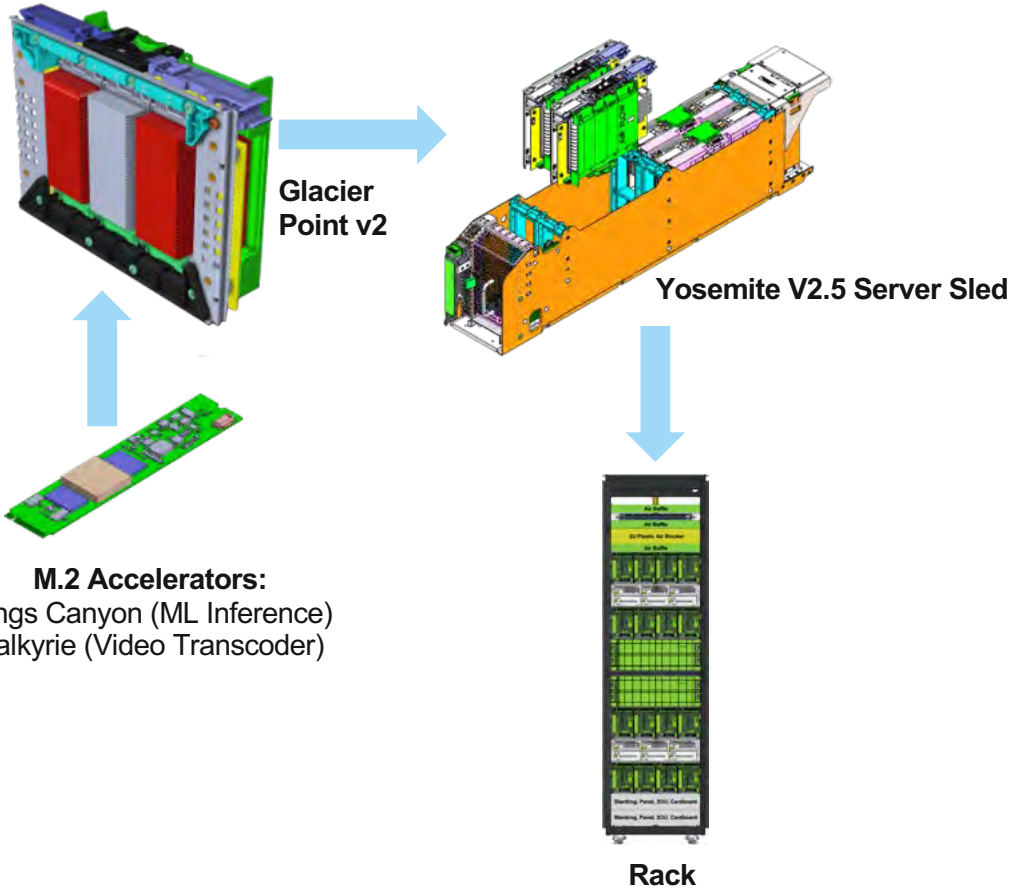
ML Training: Zion

8 x 100GbE scale-out network per node

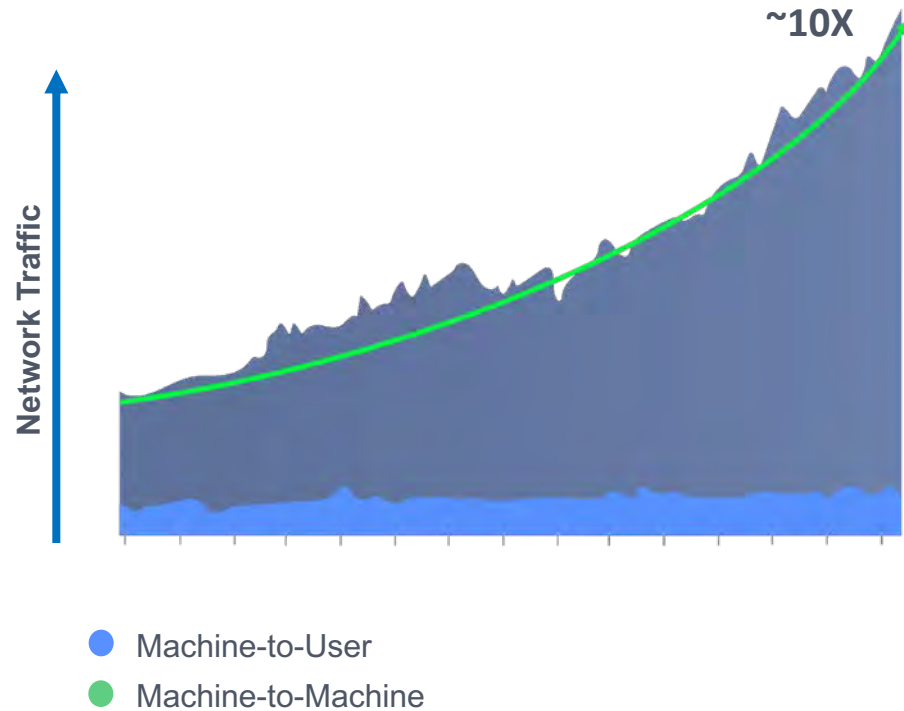


Compute Accelerator: Yosemite + Glacier Point

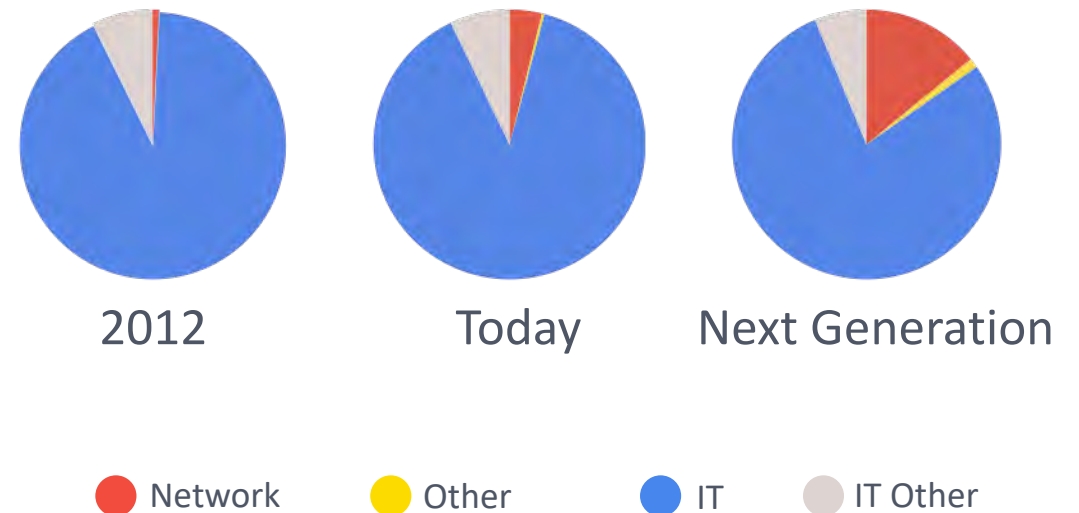
100GbE per Server



Growing Network Power Allocation

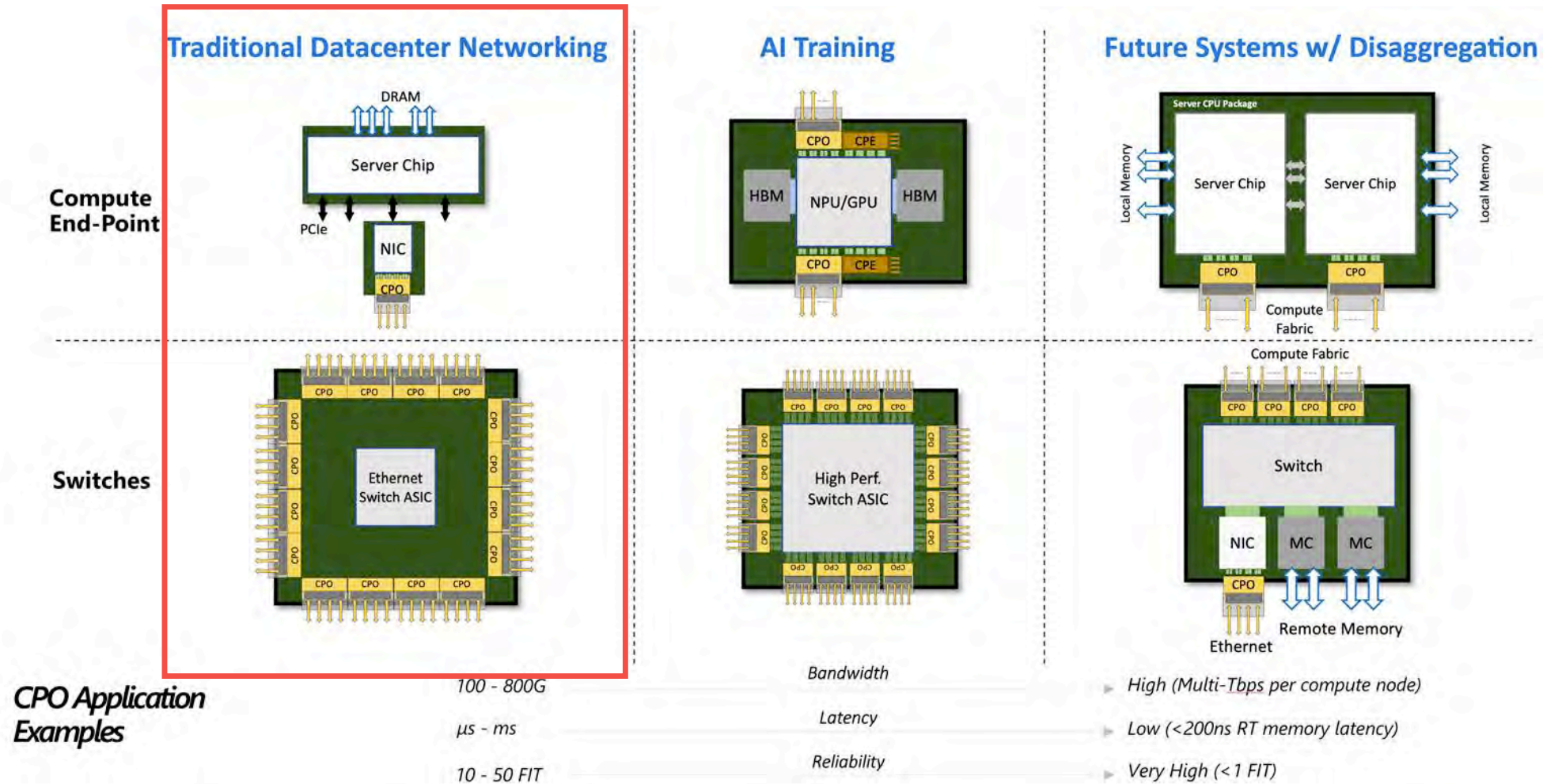


DC Power Utilization



- Networking is consuming a higher proportion of the data center power budget

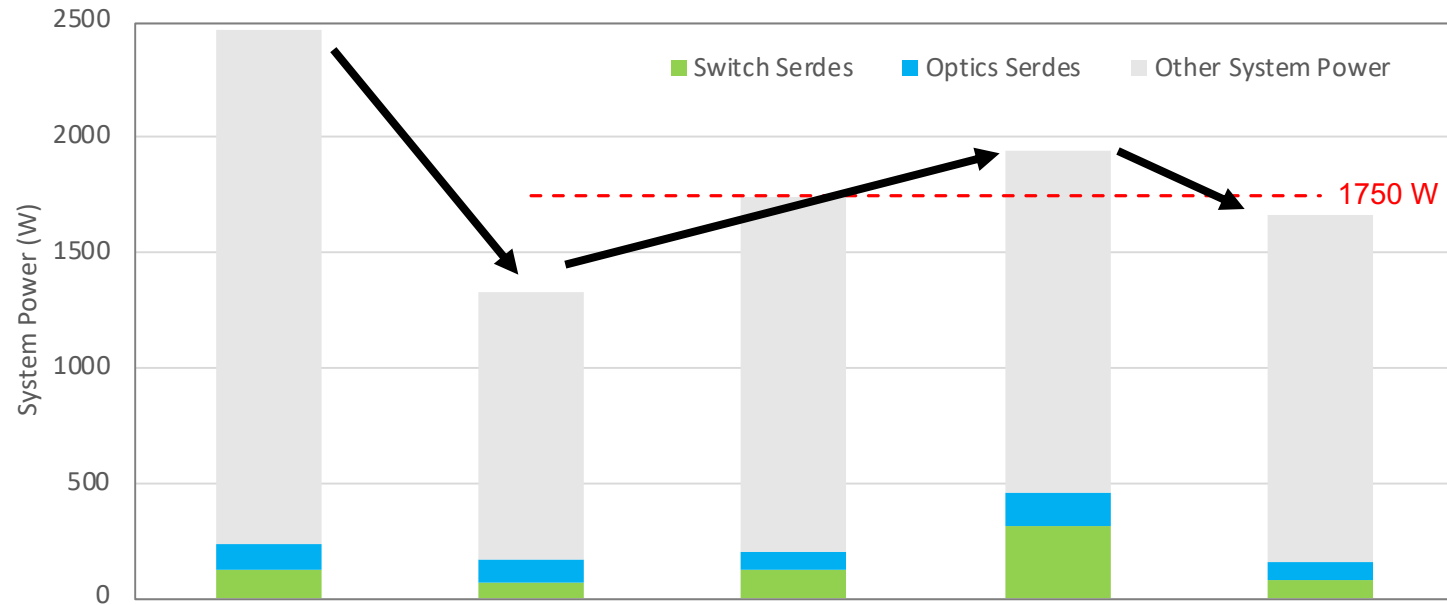
Application Areas for CPO



Anticipate a wide range of applications for CPO with alternative CPO designs



Power Reduction Motivation for CPO



	12.8T	12.8T	25.6T	51.2T	51.2T
Bandwidth	12.8T	12.8T	25.6T	51.2T	51.2T
Codename	Backpack	Minipack	Minipack 2	Next-Gen	CPO Switch
System Architecture	12 Chip, LR	Single Chip, LR	Single Chip, LR	Single Chip LR	Single Chip, XSR
Optics Form Factor	128 x 100G QSFP-28	128 x 100G QSFP-28	128 x 200G QSFP-56	128 x 400G FPP	CPO
	← Front-Panel Pluggable Optics				← Co-Packaged Optics



Backpack



Minipack

- Co packaged optics (CPO) provides the next big step in power reduction

Industry Initiatives

- CPO Demonstrations / Concepts



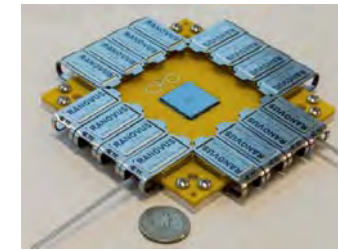
Cisco / Luxtera Mechanical Concept
OCP Summit 2018



Intel CPO Live Demo
OFC 2020



Rockley Photonics Mechanical Concept
OFC 2020

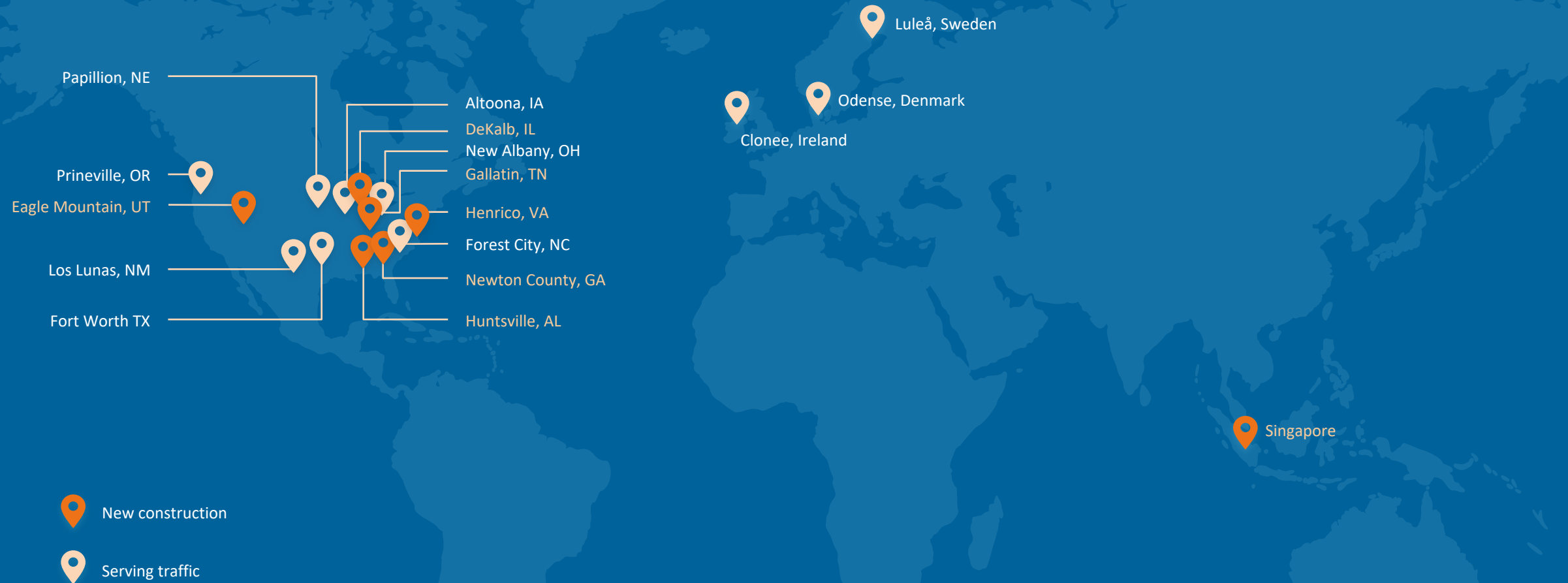


Ranovus Mechanical Concept
OFC 2020

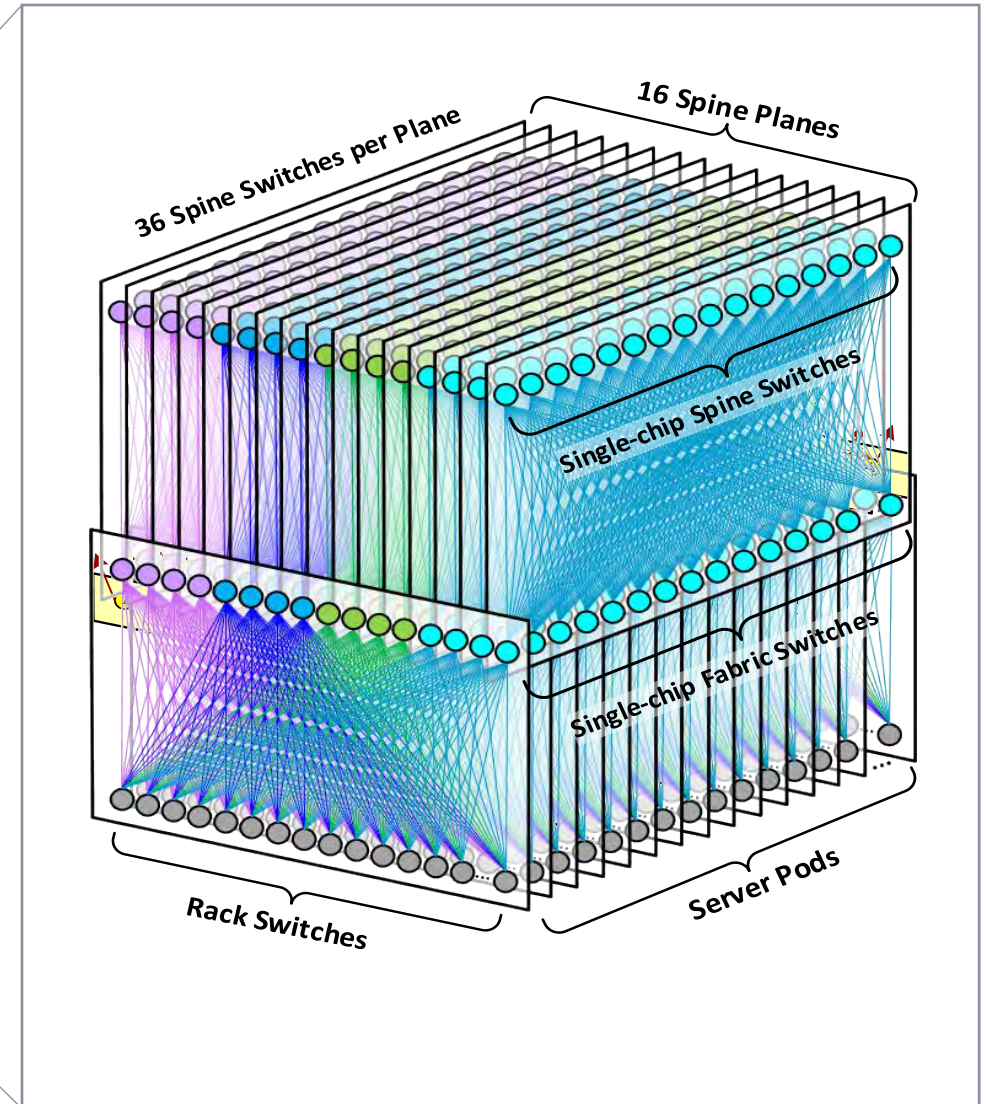
- Standards Development:

- Microsoft / Facebook JDF
www.copackagedoptics.com
- OIF CPO Framework Project
- COBO

Data center locations



Datacenter Scale



- Up to 16 plane architecture:
 - 16 x duplex fiber pairs / rack
- Connects compute, storage and switches
- Server pod: 48 racks

Networking Operational Implications at Scale

Reliability

- Challenge for CPO vs Front Panel Pluggables (FPPs)
 - Serviceable External Laser Source, spare channels possible options
- Security of Supply – broad supplier ecosystem (→ standardization)

Upgradeability

- Minimize disruption to network during upgrades
(backwards compatible modes 200GE 4 x 50G → 100GE 4 x 25G)
Forwards compatibility desirable, but harder!

Infrastructure Reuse

- Compatibility with existing network topology
(scale switch bandwidth while preserving radix)
- Maintain networking power footprint

Intra Data Center Network Evolution

FB Initial Deployment Year	Port Speed (Gb/s)	Electrical Lane Speed (Gb/s)	Switch Silicon Bandwidth (Tb/s)	Switch System Bandwidth (Tb/s)	Switch Hardware	Optical PMD	Optical Lane Speed (Gb/s/λ)	Optical Module Type		
								Front Panel Pluggable Optics	On Board Optics	Co-packaged Optics
2015	40	10	1.28 (x 12)	5.12	Six Pack	40GBASE-LR	10	QSFP+	-	-
2016	100	25	3.2 (x 12)	12.8	Backpack	100G-CWDM4 (OCP)	25	QSFP-28	-	-
2018	100	50	12.8	12.8	Minipack	100G-CWDM4 (OCP)	25	QSFP-28	Mini-Photon	-
2021	200	50	25.6	25.6	Next Gen	200G-FR4 (OCP)	50	QSFP-56	Next Gen OBO	-
2023	400	100	51.2	51.2	Next Gen	400G-FR4	100	TBD	Next Gen OBO	CPO Gen 1
...	800	200	102.4	102.4		800G-FR4	200	-	-	CPO Gen 2

Standards Development Organization

OIF

OCP

IEEE 802.3

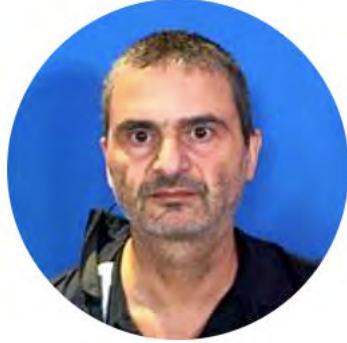
SNIA / SFF

Conclusions

- Higher network demand from new applications
- Co-packaged optics is important to enable offer power and density savings to support next generation system scaling
- Standards supported CPO ecosystem is required for wide adoption

Ongoing Priorities: scale network bandwidth power and cost efficiently

Team Acknowledgements!



Thank you!

OIF Considerations for Beyond 400ZR



Tad Hofmeister, Google



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OIF Considerations for Beyond 400ZR

Ethernet Alliance Technology Exchange Forum

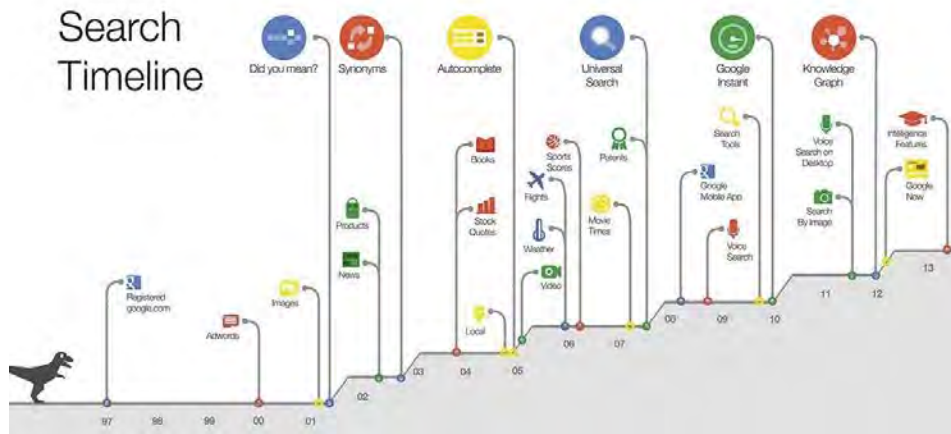
Jan. 26, 2021

Tad Hofmeister

Vice President and board member: OIF

Optical Network Architect: Google

Google Services Growth

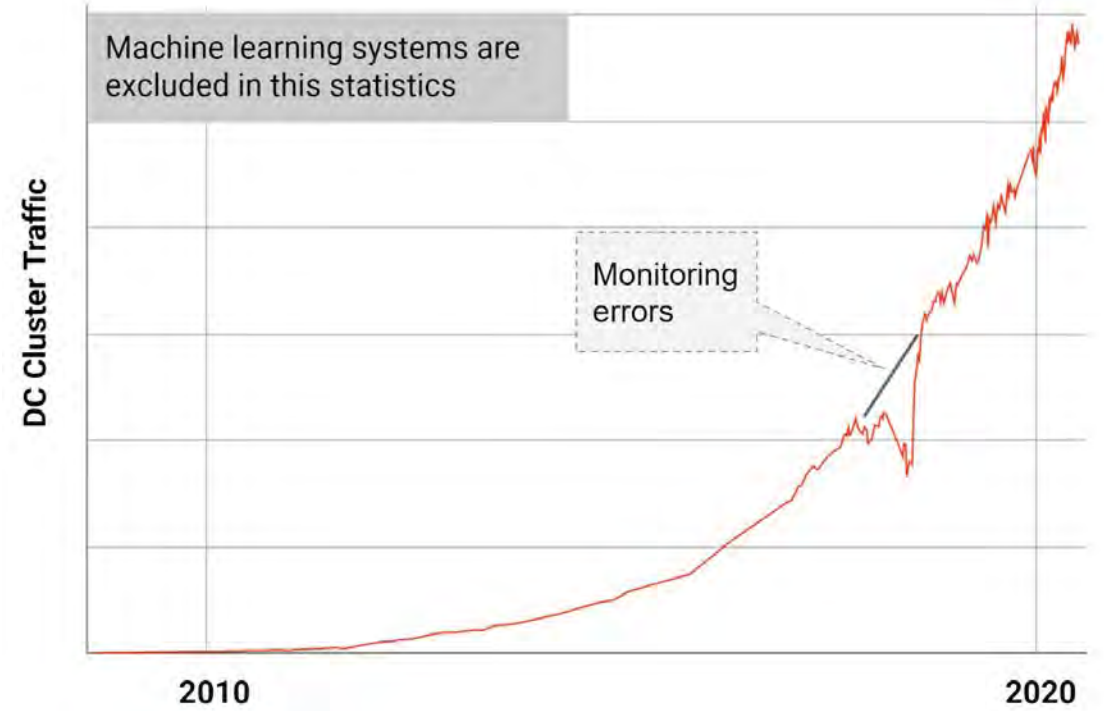


- 100 Billion searches per month
- 9+ apps with 1 Billion users
- 1 Billion individual IPs connected to by Google Cloud Platform (GCP)

Google Data Center Cluster Traffic Growth



www.google.com/about/datacenters

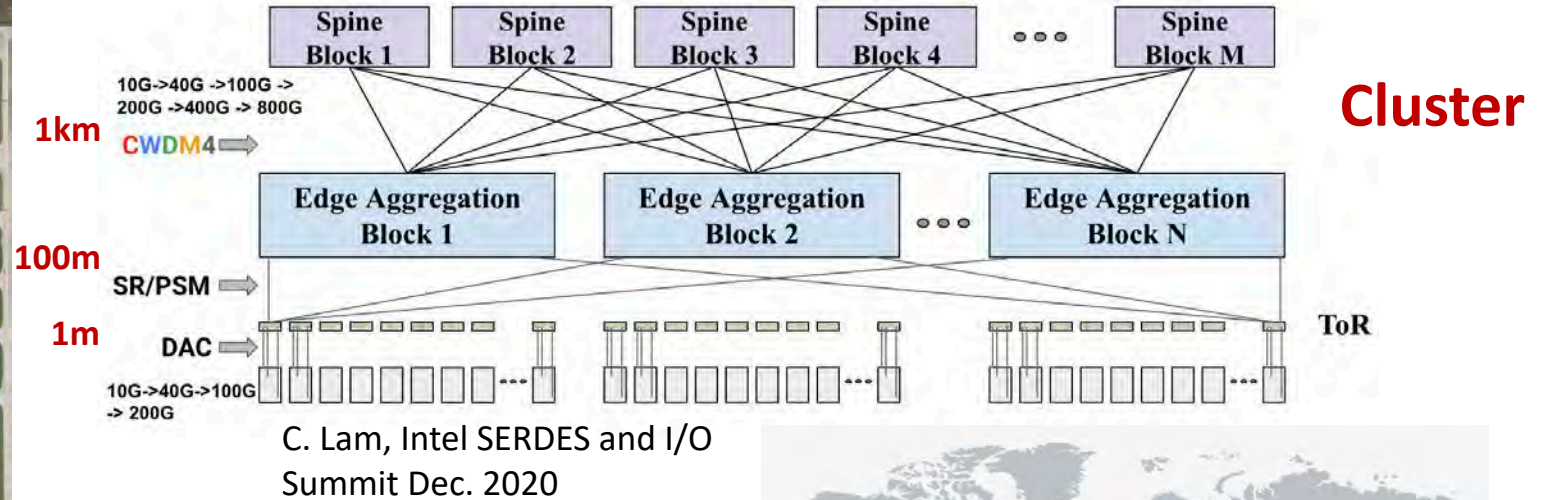


C. Lam, ECOC Workshop Dec. 2020

Node Interconnect Distances



www.google.com/maps



Cluster

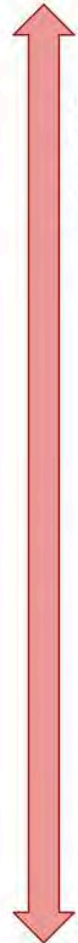
Campus
10km

WAN
10000km



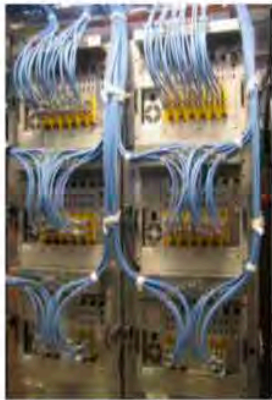
cloud.google.com/about/locations#regions

Google DC Network Evolution



5000x bandwidth increase!

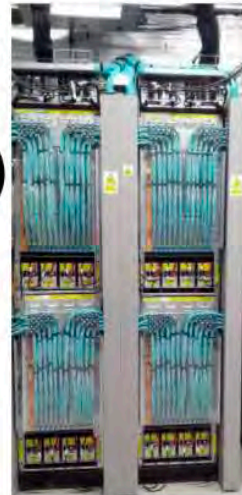
Firehose (2006)



Watchtower (2008)



Saturn (2009)



Jupiter (2012)



1.3 Petabits/sec

Jupiter 3.0 (2019)
6.5 Petabits/sec

400G OSFP



800G OSFP



Reach flexibility enabled by front panel pluggable transceivers & direct attached copper (DAC)

40G QSFP



10G SFP



Motivation for 800G Pluggables

- Front panel pluggable transceivers:
 - Enables reach flexibility per port
 - Minimize cost and power for different applications
 - DAC (meters), SR (10s m), DR (<500m), FR (<2km), LR (<10km), ZR (<120km)
 - Pay as you grow, only populate ports as needed
- 800G per transceiver capacity:
 - Maximize front panel density for improved system density
 - Lower cost per bit of transceiver
 - Higher bit rate per laser/PD
 - Fewer transceivers per Tb/s

100Gb/s Electrical IO → 800G Pluggables



800G Coherent

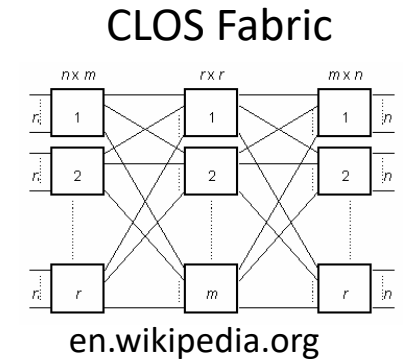


802.3 Beyond 400Gb/s
Ethernet Study Group



800G Capacity is Not Limited to 800G-Ethernet

- 8x 100GE:
 - Enables backward compatibility with legacy devices
 - Increases capacity/port-count in the same rack-space
 - Enables larger fan-out to support larger capacity CLOS fabrics
 - DAC, 800G-SR8, 800G-DR8...
- Similarly, 2x 400GE:
 - DAC, 2x400G-FR4...



OIF 800G Coherent Project

- Building on the success of the OIF's 400ZR coherent implementation agreement (IA)
- OIF Network Operator members desire similar functionality for 800G
- Prior to formal project start, the OIF NetOp WG:
 - Invited member and non-member network operators to 2 round table sessions at ECOC2019 and Microsoft OIF Day in Oct. 2019
 - Sent a beyond 400G survey to 24 network operators, receiving responses from 17 (7 hyperscalers and 10 traditional carriers) in early 2020
 - Confirmed strong demand for 800G coherent IA and enabled OIF to refine the scope of the project

800G Coherent Project Scope

- Single wavelength line interface with 2 applications:
 - Amplified, single span, DWDM links with target maximum of 80km – 120km
 - Un-amplified, fixed wavelength links with target maximum of 2km – 10km
- Support for multiplexing of independent clients:
 - 8x 100GE
 - or 2x 400GE
- IA will not be tied to a specific implementation form factor, but will include defined electrical power consumption classes, at least one of which will align with QSFP-DD800 and OSFP transceiver MSAs

Summary

- 800G Pluggable transceivers will be widely deployed
- 800G capacity for:
 - 8x 100GE
 - 2x 400GE
 - 800GE
- OIF 800G coherent project will enable interop for:
 - DWDM for campus, DCI, metro reaches
 - Single wavelength for campus reaches

OIF

Thank you!

Join Us Tomorrow, Wednesday, Jan 27th

Panel discussion – Beyond 100G Electrical

Moderator – Chris Lyon, *Ethernet Alliance President and Amphenol*

Panelists –

Cathy Liu, *Broadcom* – “*Electrical Interfaces beyond 100G*”

Nathan Tracy, *Ethernet Alliance Board Member and TE Connectivity* – “*Electrical Future Work*”

Ramin Farjad, *Marvell* – “*224G Dual Duplex Signaling over Single Lane Copper Links*”

Dave Stauffer, *OIF Representative* – “*OIF Common Electrical I/O 224G Project Overview*”

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